

EXLA1V08

Automotive high current molded inductor



Product features

- High current carrying capacity
- AEC-Q200
- Low DCR, high efficiency
- Magnetically shielded, low EMI
- Soft saturation
- Inductance range from 3.3 μ H to 10 μ H
- Current range from 8.7 A to 20 A
- 9.2 mm x 8.8 mm footprint surface mount package in a 8.0 mm height
- Alloy powder core material
- Moisture Sensitivity Level (MSL) 1

Applications

- LED lighting
- Advanced driver assistance systems (ADAS)
- Adaptive cruise control (ACC)
- Collision avoidance
- Infotainment and cluster electronics
- Battery management systems (BMS)
- Electric pumps, motor control and auxiliaries
- Powertrain control module (PCU)/Engine control module (ECM)
- Electronic Control Units (ECU)

Environmental compliance and general specifications

- Operating temperature range: -55 °C to +155 °C (ambient plus self-temperature rise)
- Storage temperature range (component): -55 °C to +155 °C
- Solder reflow temperature: J-STD-020 (latest revision) compliant



Product specifications

Part number ⁴	OCL ¹ (μ H) $\pm$ 20%	I _{rms} ² (A)	I _{sat} ³ (A)	DCR (m Ω) typical @ +25 °C	DCR (m Ω) maximum @ +25 °C	D (mm) $\pm$ 0.3
EXLA1V0808-3R3-R	3.3	18	20	6.6	7.3	6.9
EXLA1V0808-4R7-R	4.7	14.6	17	8.9	9.8	6.9
EXLA1V0808-6R8-R	6.8	11.3	12.5	13	14.3	6.9
EXLA1V0808-100-R	10	8.7	10	20.8	22.9	6.9

1. Open circuit inductance (OCL) test parameters: 100 kHz, 0.1 V_{rms}, 0.0 Adc, +25 °C

2. I_{rms}: Heat rated current (I_{rms}) will cause the part temperature rise approximately ΔT of 40 °C. Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application. The part temperature (ambient + temp rise) should not exceed +155 °C under worst case operating conditions.

3. I_{sat}: Peak current for approximately 30% rolloff @ +25 °C

4. Part number definition: EXLA1V0808-xxx-R

EXLA1V0808 = Product code and size

xxx= inductance value in μ H, R= decimal point,

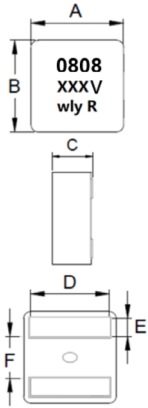
If no R is present then third digit equals the number of zeros

-R suffix = RoHS compliant

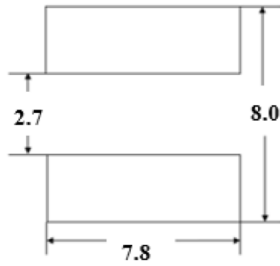
5. Rated operating voltage (across inductor) 40 V ref.

Mechanical parameters, schematic, pad layout (mm)

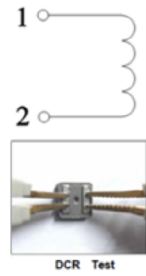
EXLA1V0808



Recommended pad layout



Schematic



Part number	A	B	C	D	E	F
EXLA1V0808-xxx-R	8.9 $\pm$ 0.30	8.5 $\pm$ 0.30	7.7 $\pm$ 0.20	See spec table	1.8 $\pm$ 0.20	3.5 $\pm$ 0.30

Part marking: 0808

xxx= = Inductance value in μ H (R= decimal point, if no R is present last digit equals number of zeros, V= vehicle, wly R= lot code)

All soldering surfaces to be coplanar within 0.1 millimeters

Tolerances are $\pm$ 0.3 millimeters unless stated otherwise

Dimensions of recommended PCB layout are reference only.

Pad layout tolerances are $\pm$ 0.1 millimeters unless stated otherwise

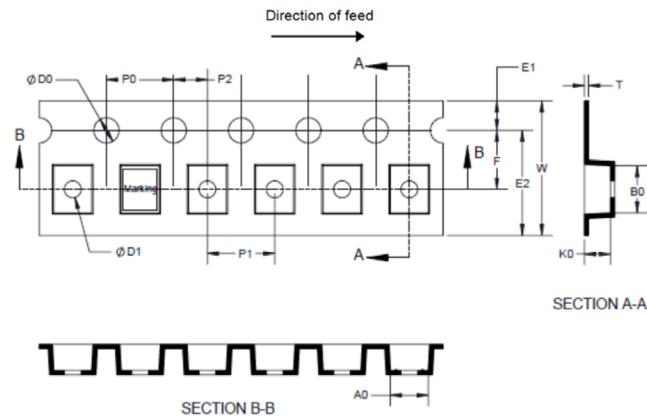
Four terminal kelvin-clip recommended for DCR testing

Traces or vias underneath the inductor is not recommended.

Packaging information (mm)

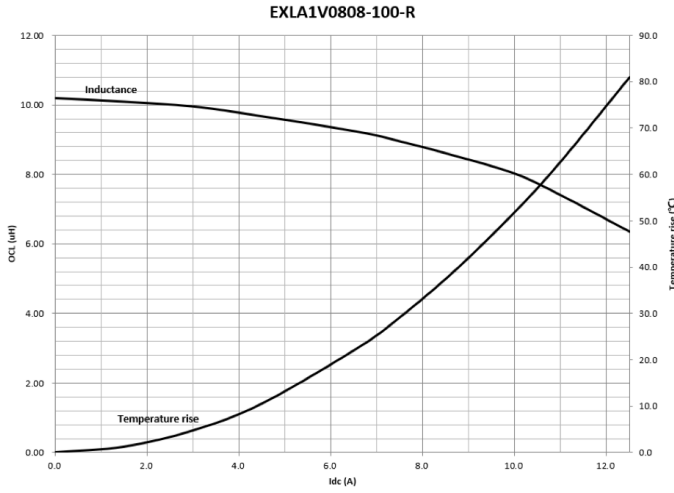
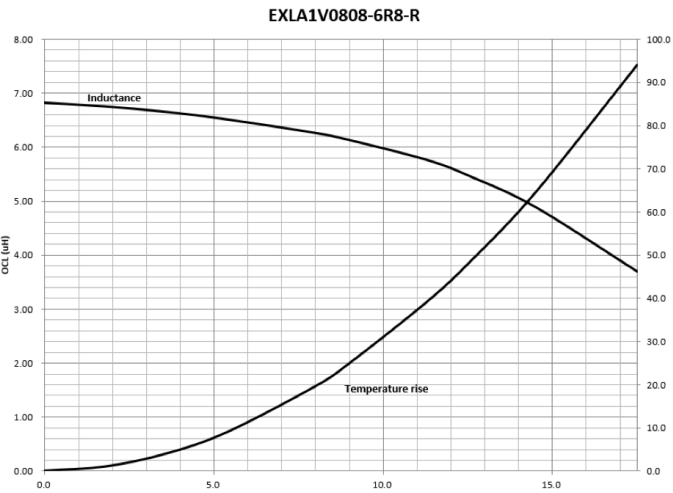
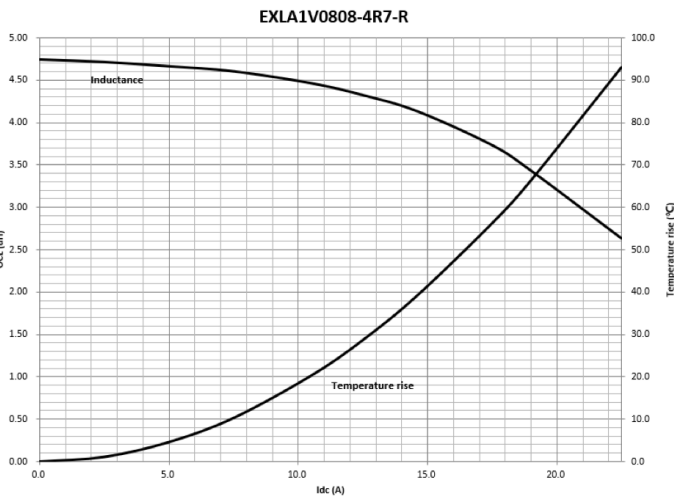
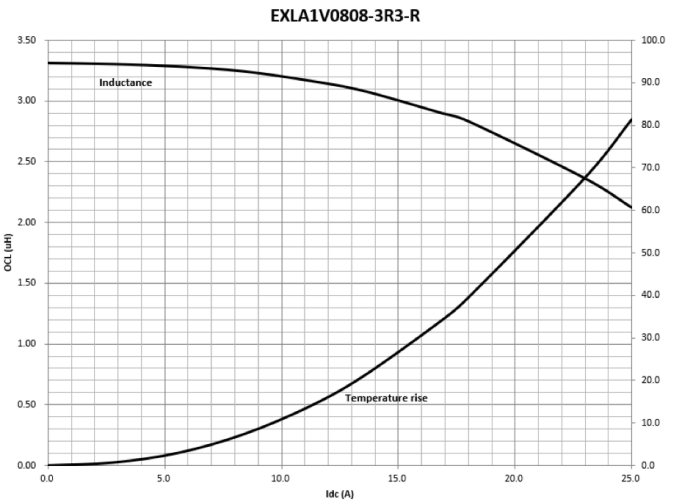
Supplied in tape and reel packaging, 450 parts per 13" diameter reel (EIA-481 compliant)

Drawing not to scale

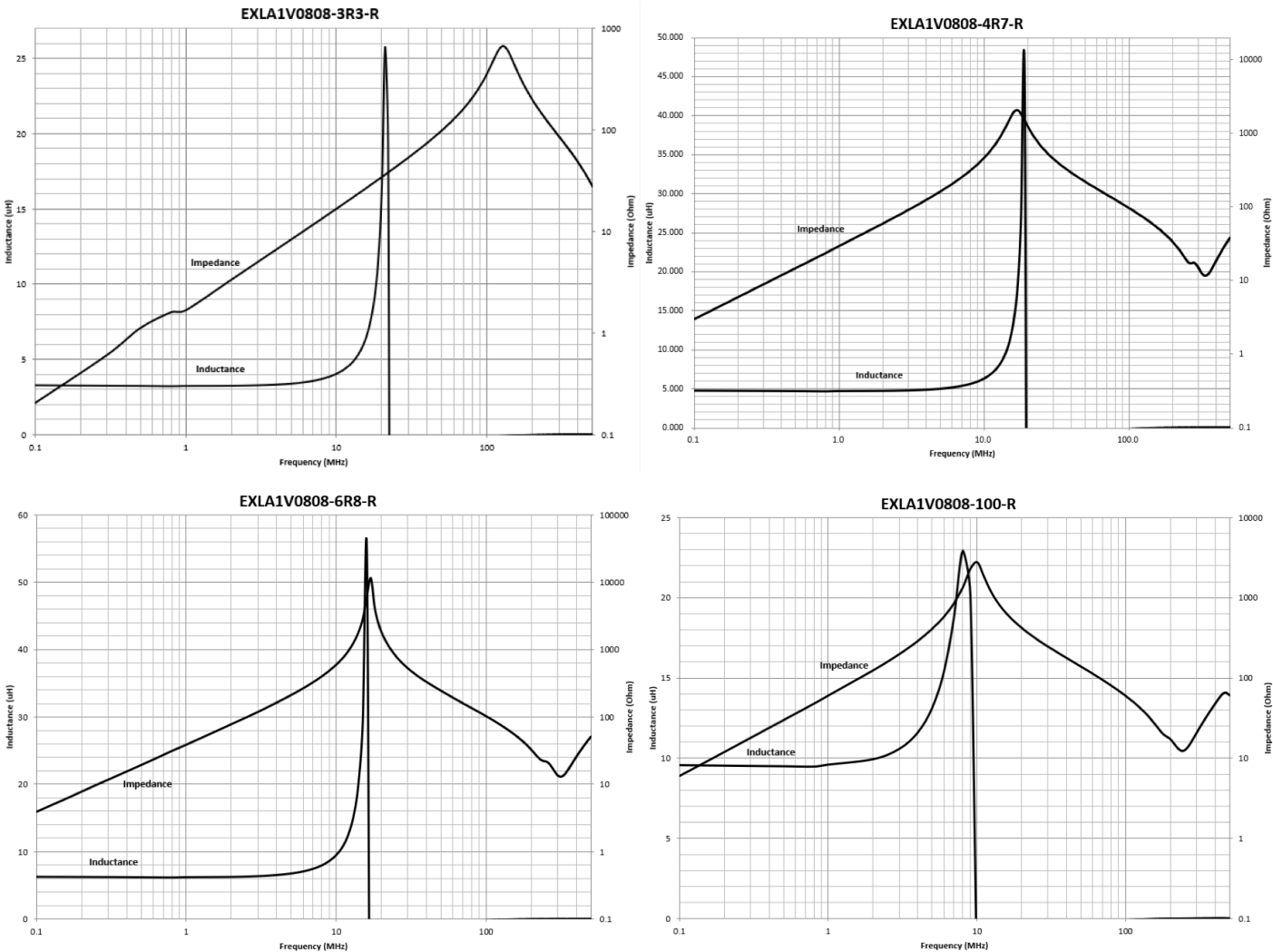


$W \pm 0.30$	24
$F \pm 0.1$	7.5
$E1 \pm 0.10$	1.75
$E2 \text{ Min}$	22.25
$P0 \pm 0.10$	4
$P1 \pm 0.10$	16
$P2 \pm 0.1$	2
$D0 + 0.10 / -0$	1.5
$D1 + 0.10 / -0$	1.5
$A0 \pm 0.10$	9.4
$B0 \pm 0.10$	8.9
$K0 \pm 0.10$	8.5
$T \pm 0.05$	0.35

Inductance and temperature rise vs. current



Inductance and impedance vs frequency curve



Solder reflow profile

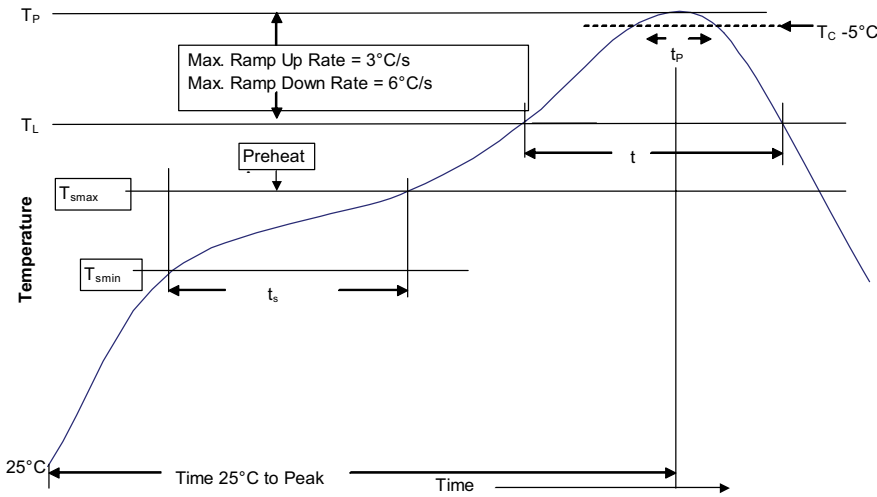


Table 1 - Standard SnPb solder (T_c)

Package thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_c)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak		
• Temperature min. (T_{smin})	100 °C	150 °C
• Temperature max. (T_{smax})	150 °C	200 °C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds	60-120 seconds
Ramp up rate T_L to T_p	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T_L)	183 °C	217 °C
Time (t_L) maintained above T_L	60-150 seconds	60-150 seconds
Peak package body temperature (T_p)*	Table 1	Table 2
Time (t_p)* within 5 °C of the specified classification temperature (T_c)	20 seconds*	30 seconds*
Ramp-down rate (T_p to T_L)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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